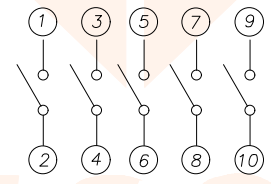
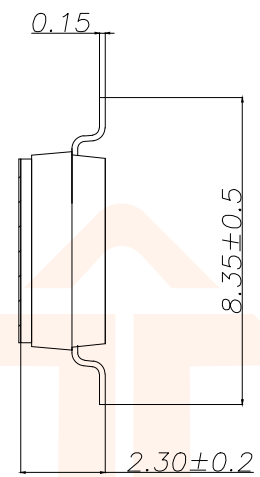
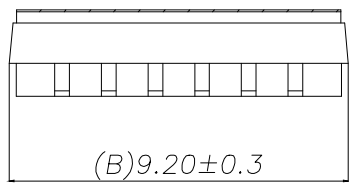
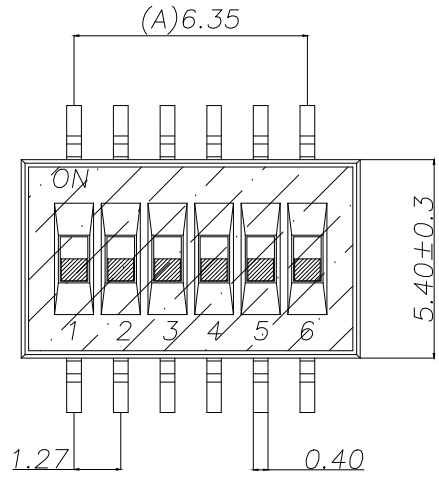
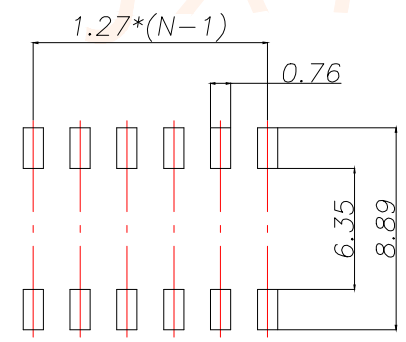




REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



[Schematic]



[P.C.B.LAYOUT]

NOTES:

1.Specification:

- 1>.Operation force: 1000gf Max.
- 2>.Operation Temperature: -30℃ to +85℃.
- 3>.Storage Temperature: -40℃ to +85℃.
- 4>.Mechanical Life: 1000 cycles operations.
- 5>.Resistance to Soldering: 260±5℃ for 3-5 Seconds.

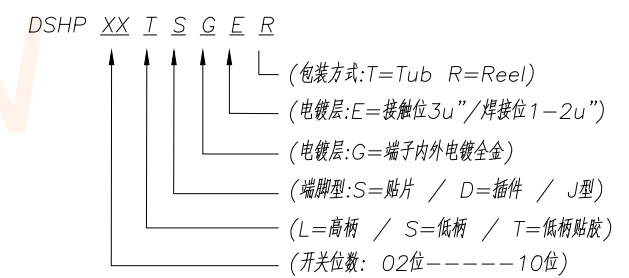
2.PLATING:

- 1>.GOLD flash 1u"(min) SOLDERTAIL, 3u" GOLD PLATING ON THE CONTACT AREA.

3.ELECTRICAL:

- 1>.Non-switch Rating: 100mA at 50V DC.
- 2>.Switching Rating: 25mA at 24V DC.
- 3>.Contact Resistance: Initial 50mΩ Max. Contact Resistance: After life 100mΩ Max.
- 4>.Insulation Resistance: 100MΩ Min at 100VDC.
- 5>.Dielectric Strength: 300V AC for 60seconds.
- 6>.Switch Capacitance: 5PF Max at 1MHZ.

4.PART NUMBER DESCRIPTION:



5.PACKING: 2000pcs/Reel/Box.

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd		
>0±0.05	>0°±0.5°	PART NO.	TITLE: PRODUCT Family DSHP	
>1±0.10	>5°±1.0°	DSHP06TSGER		Series Pitch 1.27mm
>10±0.30		DESIGN: Ethan	MANUFACTURE DWG	
UNITS	mm	CHED: Olivia		
MATERILA	---	APPD: Ava		
FINISH	---			
			SCALE N:A SHEET 1/1	